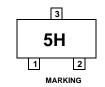


MMBD4148/SE/CC/CA





MMBD4148 5H MMBD4148CA D6 MMBD4148CC D5 MMBD4148SE D4

4148 4148SE 3 4148CC 3 4148CA 4148CA

Connection Diagram

Small Signal Diode

Absolute Maximum Ratings * T_A = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{RRM}	Maximum Repetitive Reverse Voltage	100	V
I _{F(AV)}	Average Rectified Forward Current	200	mA
I _{FSM}	Non-repetitive Peak Forward Surge Current Pulse Width = 1.0 second Pulse Width = 1.0 microsecond	1.0 2.0	A
T _{STG}	Storage Temperature Range	-55 to +150	°C
TJ	Operating Junction Temperature	150	°C

^{*} These ratings are limiting values above which the serviceability of the diode may be impaired.

Thermal Characteristics

Symbol	Parameter	Value	Units
P _D	Power Dissipation	350	mW
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W

Electrical Characteristics T_A=25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Max.	Units
V_R	Breakdown Voltage	$I_R = 5.0 \mu A$	75		V
		$I_{R} = 100 \mu A$	100		V
V _F	Forward Voltage	I _F = 10mA		1.0	V
I _R	Reverse Leakage Current	V _R = 20V		25	nA
		$V_R = 20V, T_A = 150^{\circ}C$		50	μΑ
		V _R =75V		5.0	μΑ
C _T	Total Capacitance	$V_R = 0V$, $f = 1.0MHz$		4.0	pF
t _{rr}	Reverse Recovery Time	$I_F = 10 \text{mA}, V_R = 6.0 \text{V},$		4.0	ns
		$I_{RR} = 1.0 \text{mA}, R_{L} = 100 \Omega$			

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Typical Characteristics

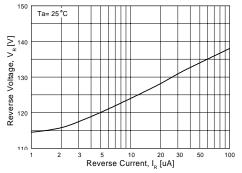


Figure 1. Reverse Voltage vs Reverse Current BV - 1.0 to 100uA

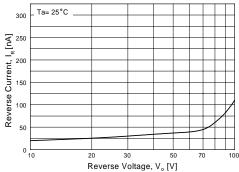


Figure 2. Reverse Current vs Reverse Voltage IR - 10 to 100 V

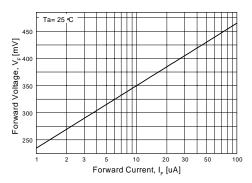


Figure 3. Forward Voltage vs Forward Current VF - 1.0 to 100 uA

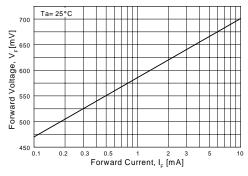


Figure 4. Forward Voltage vs Forward Current VF - 0.1 to 10 mA

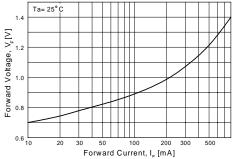


Figure 5. Forward Voltage vs Forward Current VF - 10 - 800 mA

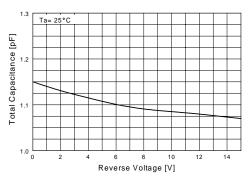


Figure 6. Total Capacitance vs Reverse Voltage

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Typical Characteristics (continued)

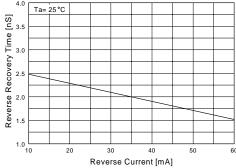


Figure 7. Reverse Recovery Time vs Reverse Current TRR - IR 10 mA vs 60 mA

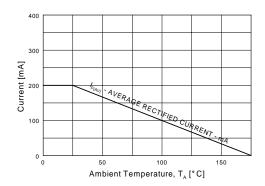


Figure 8. Average Rectified Current $(I_{F(AV)})$ versus Ambient Temperature $(T_{_A})$

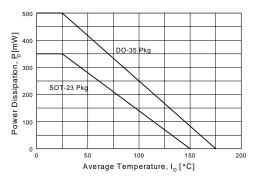


Figure 9. Power Derating Curve

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